

# VBQA2611 Datasheet

## P-Channel 60 V (D-S) 175 °C MOSFET

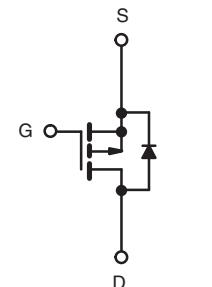
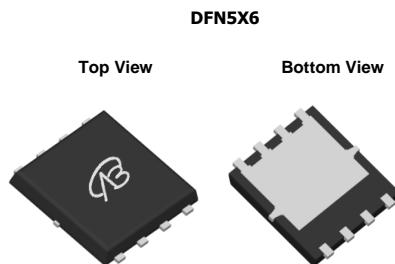
PRODUCT SUMMARY	
$V_{DS}$ (V)	-60
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS} = -10$ V	0.011
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS} = -4.5$ V	0.014
$I_D$ (A)	-60
Configuration	Single
Package	DFN 5X6

### FEATURES

- Trench power MOSFET
- 100 %  $R_g$  and UIS tested



**RoHS**  
COMPLIANT  
**HALOGEN**  
**FREE**



ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		$V_{DS}$	-60	V
Gate-Source Voltage		$V_{GS}$	$\pm 30$	
Continuous Drain Current	$T_C = 25$ °C	$I_D$	-60	A
	$T_C = 125$ °C		-36	
Continuous Source Current (Diode Conduction) <sup>a</sup>		$I_S$	-180	
Pulsed Drain Current <sup>b</sup>		$I_{DM}$	-100	
Single Pulse Avalanche Current	$L = 0.1$ mH	$I_{AS}$	-36	mJ
Single Pulse Avalanche Energy		$E_{AS}$	64.8	
Maximum Power Dissipation <sup>b</sup>	$T_C = 25$ °C	$P_D$	68	W
	$T_C = 125$ °C		22	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	-55 to +175	°C
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount <sup>c</sup>	$R_{thJA}$	68	°C/W
Junction-to-Case (Drain)		$R_{thJC}$	2.2	

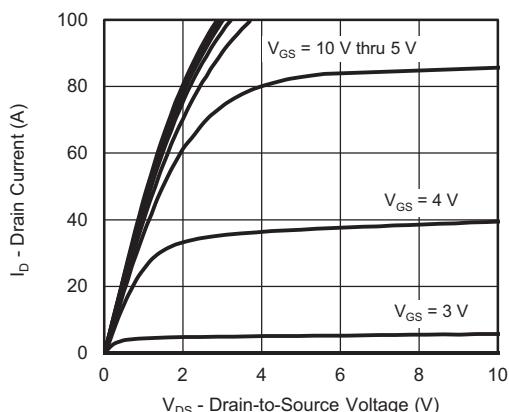
### Notes

- Package limited.
- Pulse test; pulse width  $\leq 300$   $\mu$ s, duty cycle  $\leq 2$  %.
- When mounted on 1" square PCB (FR4 material).

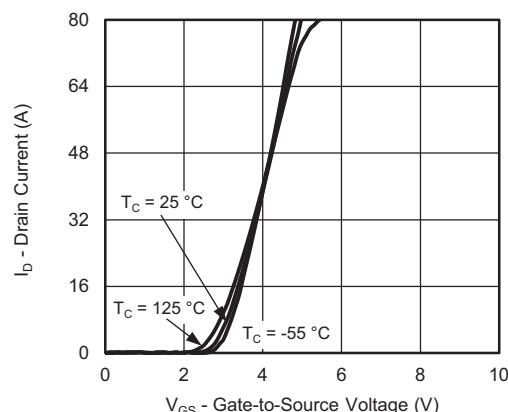
SPECIFICATIONS ( $T_C = 25^\circ\text{C}$ , unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
<b>Static</b>								
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0$ , $I_D = -250 \mu\text{A}$	-60	-	-		V	
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$ , $I_D = -250 \mu\text{A}$	-1.5	-	-3.5			
Gate-Source Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}$ , $V_{GS} = \pm 30 \text{ V}$	-	-	$\pm 100$	nA		
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{GS} = 0 \text{ V}$	$V_{DS} = -60 \text{ V}$	-	-	-1	$\mu\text{A}$	
		$V_{GS} = 0 \text{ V}$	$V_{DS} = -48 \text{ V}$ , $T_J = 125^\circ\text{C}$	-	-	-50		
		$V_{GS} = 0 \text{ V}$	$V_{DS} = -48 \text{ V}$ , $T_J = 175^\circ\text{C}$	-	-	-150		
On-State Drain Current <sup>a</sup>	$I_{D(\text{on})}$	$V_{GS} = -10 \text{ V}$	$V_{DS} \geq -5 \text{ V}$	-30	-	-	A	
Drain-Source On-State Resistance <sup>a</sup>	$R_{DS(\text{on})}$	$V_{GS} = -10 \text{ V}$	$I_D = -10 \text{ A}$	-	0.011	-	$\Omega$	
		$V_{GS} = -10 \text{ V}$	$I_D = -10 \text{ A}$ , $T_J = 125^\circ\text{C}$	-	0.024	-		
		$V_{GS} = -10 \text{ V}$	$I_D = -10 \text{ A}$ , $T_J = 175^\circ\text{C}$	-	0.036	-		
		$V_{GS} = -4.5 \text{ V}$	$I_D = -5 \text{ A}$	-	0.014	-		
Forward Transconductance <sup>b</sup>	$g_{fs}$	$V_{DS} = -15 \text{ V}$ , $I_D = -10 \text{ A}$		-	26	-	S	
<b>Dynamic <sup>b</sup></b>								
Input Capacitance	$C_{iss}$	$V_{GS} = 0 \text{ V}$	$V_{DS} = -25 \text{ V}$ , $f = 1 \text{ MHz}$	-	4000		pF	
Output Capacitance	$C_{oss}$			-	310	450		
Reverse Transfer Capacitance	$C_{rss}$			-	200	275		
Total Gate Charge <sup>c</sup>	$Q_g$	$V_{GS} = -10 \text{ V}$	$V_{DS} = -30 \text{ V}$ , $I_D = -5 \text{ A}$	-	6 0	100	nC	
Gate-Source Charge <sup>c</sup>	$Q_{gs}$			-	9.5	-		
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			-	19	-		
Gate Resistance	$R_g$	$f = 1 \text{ MHz}$		0.50	1.19	1.80	$\Omega$	
Turn-On Delay Time <sup>c</sup>	$t_{d(\text{on})}$	$V_{DD} = -30 \text{ V}$ , $R_L = 6 \Omega$ $I_D \approx -5 \text{ A}$ , $V_{GEN} = -10 \text{ V}$ , $R_g = 1 \Omega$		-	15	25	ns	
Rise Time <sup>c</sup>	$t_r$			-	5	10		
Turn-Off Delay Time <sup>c</sup>	$t_{d(\text{off})}$			-	40	75		
Fall Time <sup>c</sup>	$t_f$			-	6	12		
<b>Source-Drain Diode Ratings and Characteristics <sup>b</sup></b>								
Pulsed Current <sup>a</sup>	$I_{SM}$			-	-	-180	A	
Forward Voltage	$V_{SD}$	$I_F = -10 \text{ A}$ , $V_{GS} = 0 \text{ V}$		-	-0.80	-1.2	V	

**Notes**

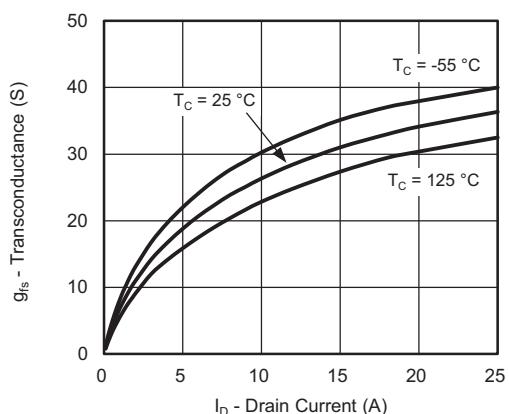
- a. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

**TYPICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)


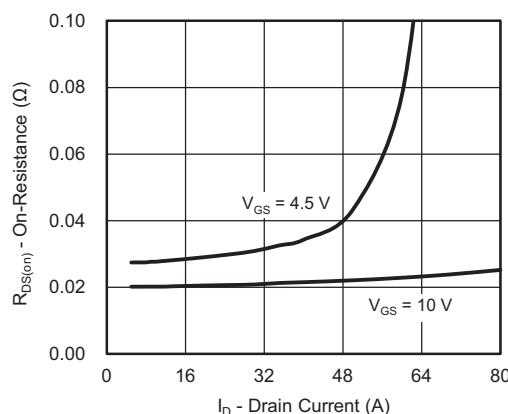
Output Characteristics



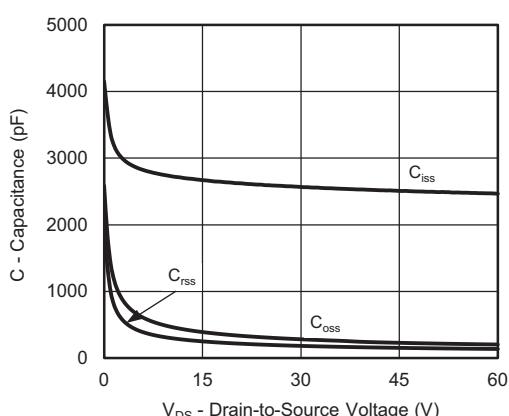
Transfer Characteristics



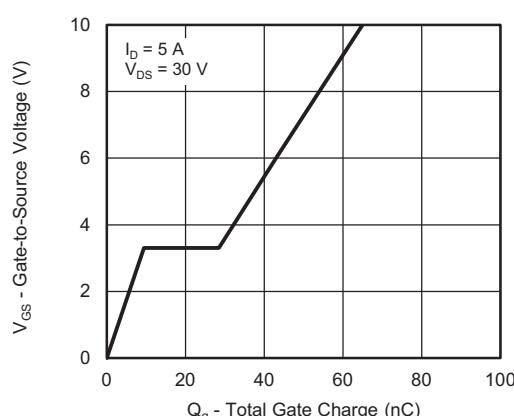
Transconductance



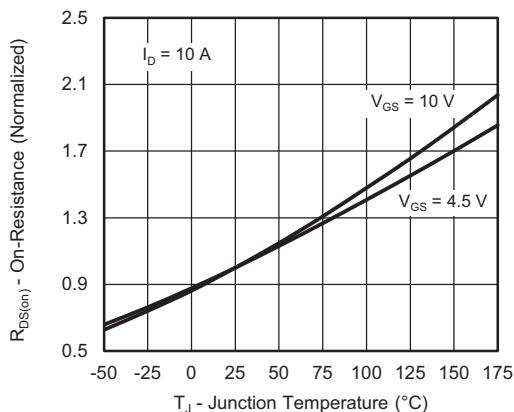
On-Resistance vs. Drain Current



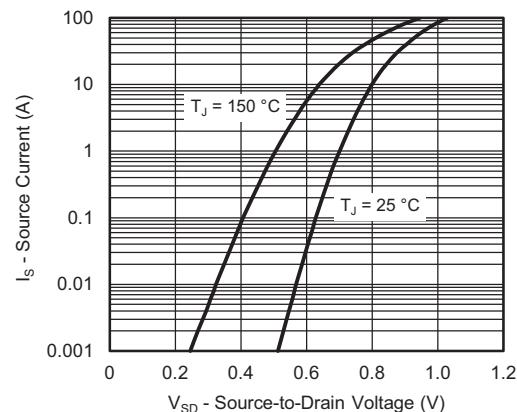
Capacitance



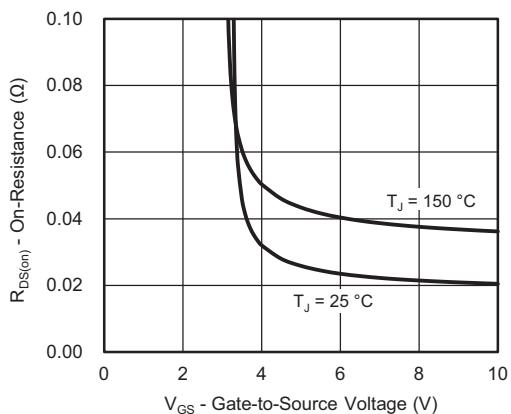
Gate Charge

**TYPICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)


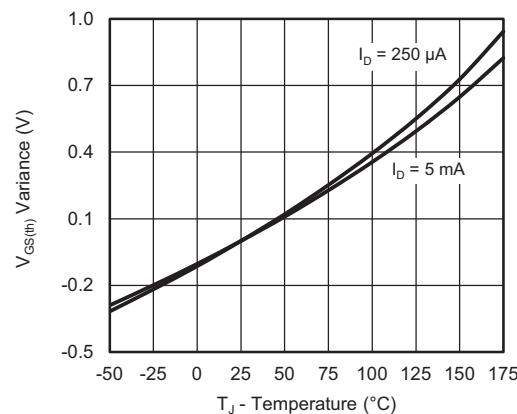
On-Resistance vs. Junction Temperature



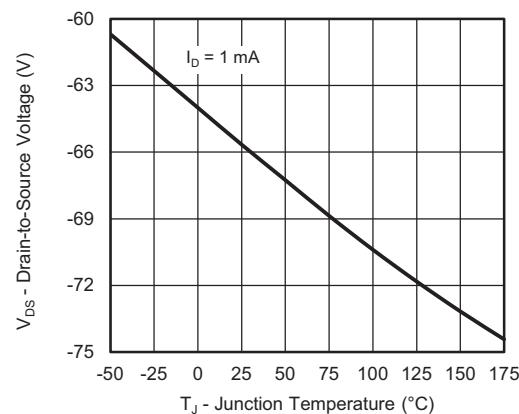
Source Drain Diode Forward Voltage



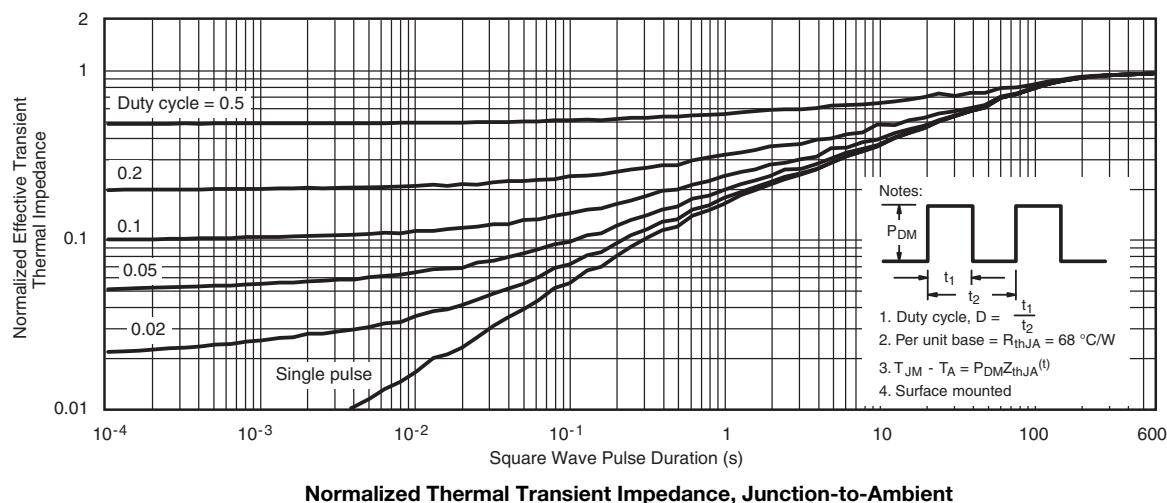
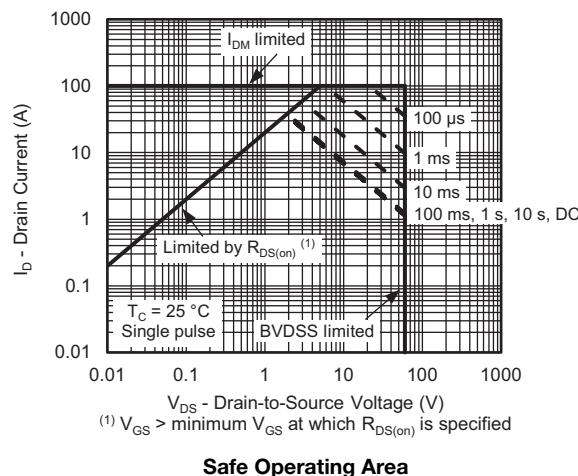
On-Resistance vs. Gate-to-Source Voltage

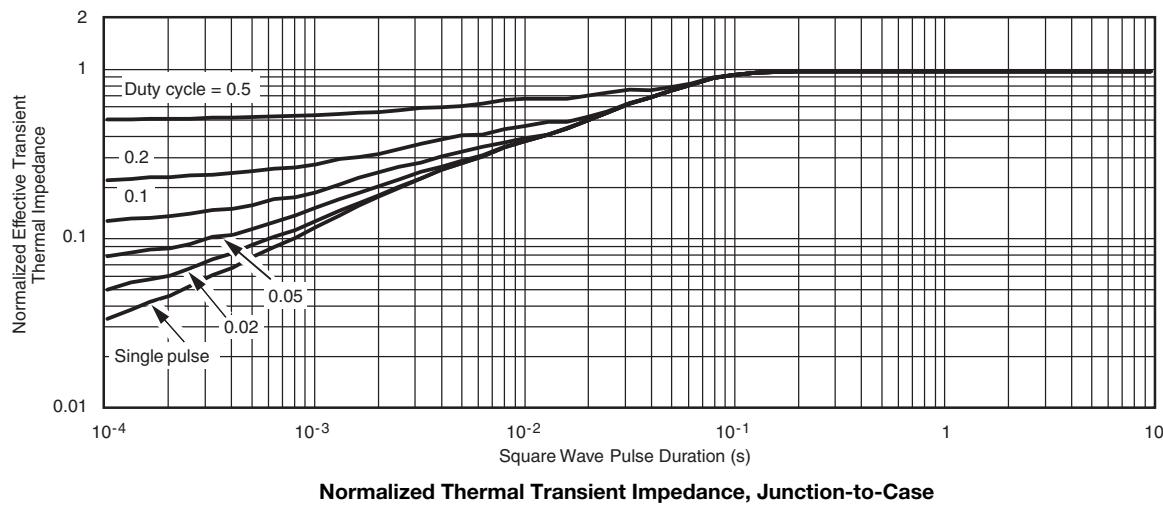


Threshold Voltage



Drain-Source Breakdown vs. Junction Temperature

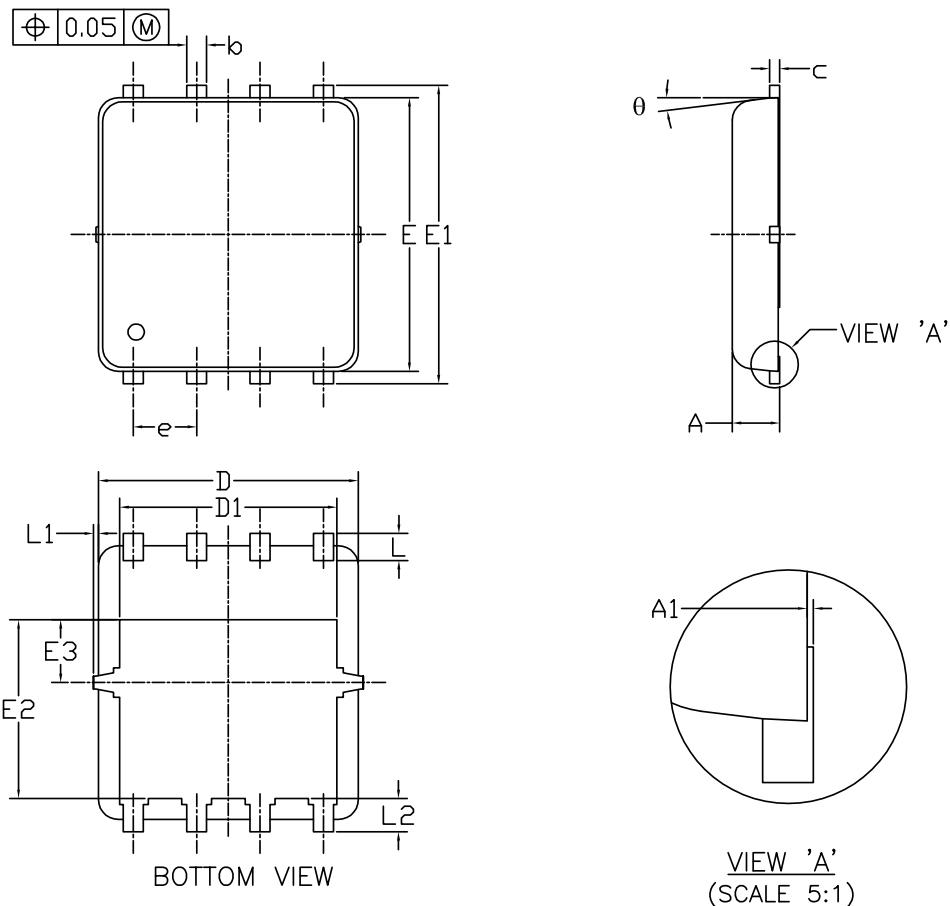
**THERMAL RATINGS** ( $T_C = 25^\circ\text{C}$ , unless otherwise noted)


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**Note**

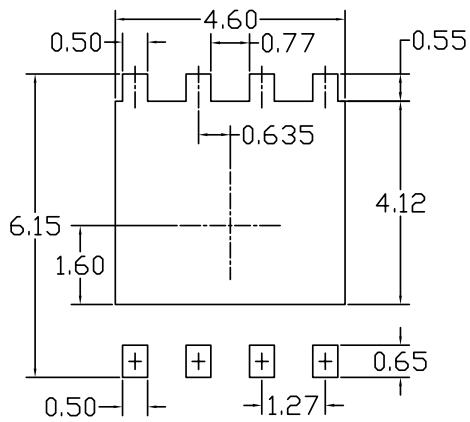
- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

## DFN5x6\_8L\_EP1\_P PACKAGE OUTLIN



## RECOMMENDED LAND PATTERN



UNIT: mm

## NOTE

1. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.  
MOLD FLASH AT THE NON-LEAD SIDES SHOULD BE LESS THAN 6 MILS EACH.
2. CONTROLLING DIMENSION IS MILLIMETER.  
CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.

SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.85	0.95	1.00	0.033	0.037	0.039
A1	0.00	---	0.05	0.000	---	0.002
b	0.30	0.40	0.50	0.012	0.016	0.020
c	0.15	0.20	0.25	0.006	0.008	0.010
D	5.10	5.20	5.30	0.201	0.205	0.209
D1	4.25	4.35	4.45	0.167	0.171	0.175
E	5.45	5.55	5.65	0.215	0.219	0.222
E1	5.95	6.05	6.15	0.234	0.238	0.242
E2	3.525	3.625	3.725	0.139	0.143	0.147
E3	1.175	1.275	1.375	0.046	0.050	0.054
e	1.27 BSC			0.050 BSC		
L	0.45	0.55	0.65	0.018	0.022	0.026
L1	0	---	0.15	0	---	0.006
L2	0.68 REF			0.027 REF		
θ	0°	---	10°	0°	---	10°

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